Equipment Information Sheet **P7 Profilometer**

Manager: Philip Schneider 607-254-4931 Backup: Jeremy Clark 607-254-6487 Backup: Giovanni Sartorello 607-254-4853

SAFETY

• No unusual hazards during normal operation.

USAGE RESTRICTIONS

• No buddy system restrictions imposed on normal operation.

SCHEDULING/SIGN-UP RESTRICTIONS

Minimum Tool Time: 5 minutes

• None at this time.

MATERIALS COMPATIBILITY CATEGORY

Tool Category 5: Class A and B Metals and Compounds

Allowed	Not Allowed
Tool category 1/1E, 2, 3, and 4 materials	
Silicon Based Substrates and Films	
III/V compound Semiconductors	
Glass Substrates	
PECVD and ALD Films	
Cured organics and baked Photoresist	
CNF Class A, B, and Refractory metals	
Exposed Gold, Silver, Copper	
Alkali and Alkaline Compounds	
Organic/Biology Molecules prepared- w/salt buffers	
High Vapor Pressure Materials (Mg, Ca, Zn)*	* Some tool restrictions on high vapor pressure materials may apply
Soft organic materials	

High Vapor Pressure Metals and Compounds are materials that have a vapor pressure above 1e-6 Torr at 400 C.

Additional Material Restrictions and Exceptions

- Samples must be clean: No Acid or Base Residues on top or back.
- Standard semiconductor manufacturing materials allowed. Contact machine manager about other materials.
- No Objects greater than 150mm diameter or smaller then 10mmx10mm

Last Updated: 07/25/2025

Calls to staff phones will be automatically forwarded to their cell phones during accessible hours. At other times leave a message or send them an email.